

HM6708SH/HM6709SH Series

TTL I/O**65,536-words × 4-bits High Speed Static Random Access Memory**

Features

- 65,536 words × 4 bits organization
- Fully compatible with TTL input and output
- 0.8 μm Hi-BiCMOS process
- +5 V single power supply
- Completely static memory: No clock or timing strobe required
- Low power dissipation (DC) operating: 400 mW typ
- Super fast access time: 10/12 ns max

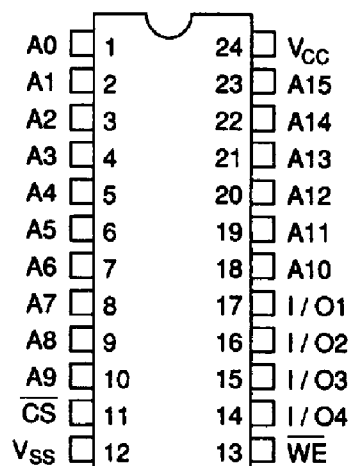
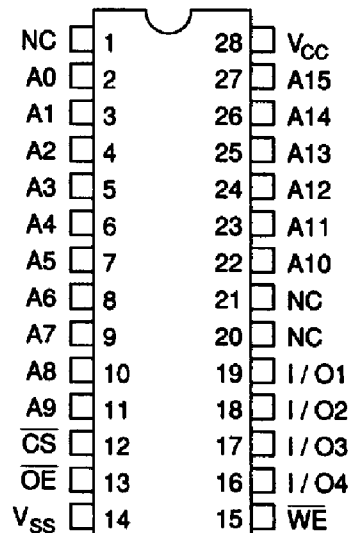
Ordering Information

Type No.	Access time	Package
HM6708SHJP-10	10 ns	300-mil 24-pin plastic SOJ (CP-24D)
HM6708SHJP-12	12 ns	
HM6709SHJP-10	10 ns	300-mil 28-pin plastic SOJ (CP-28DN)
HM6709SHJP-12	12 ns	

Pin Description

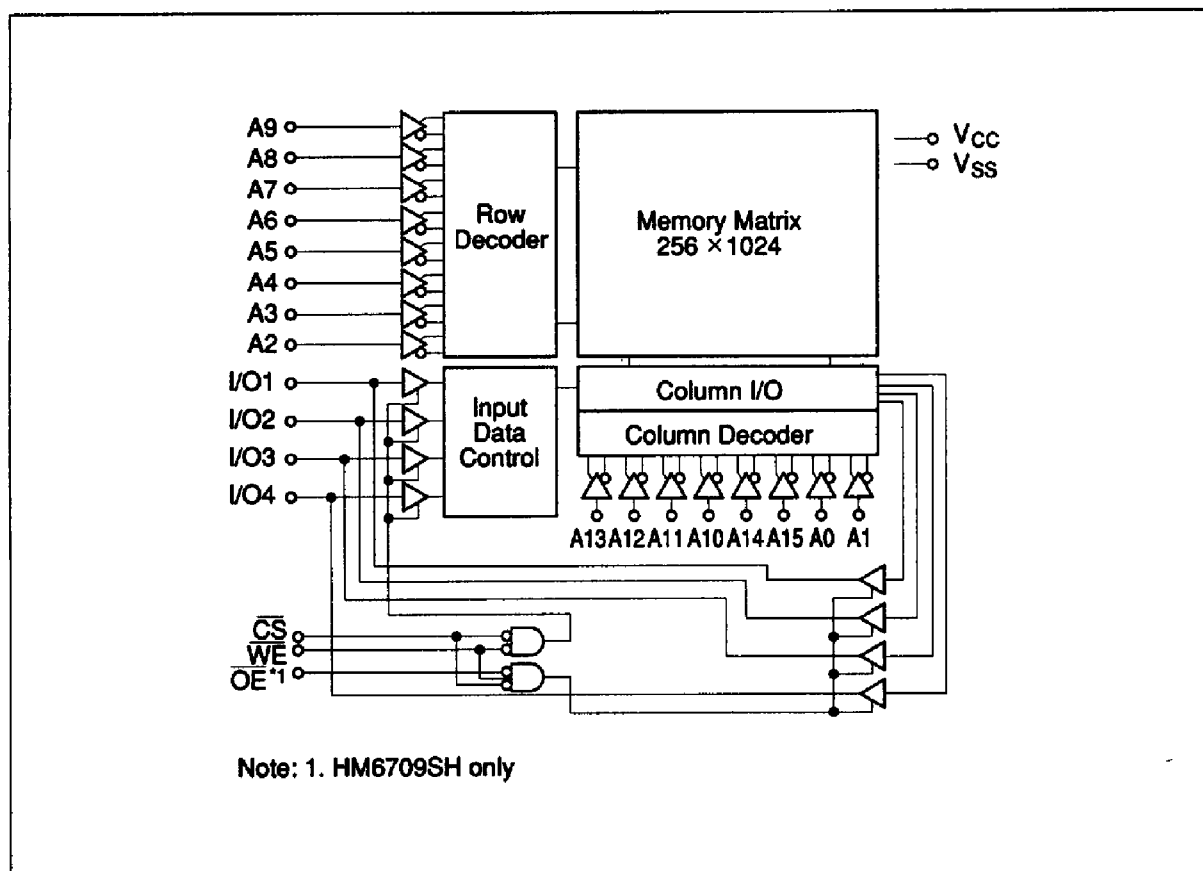
Pin name	Function
A0–A15	Address input
I/O1–I/O4	Data input/output
WE	Write enable
CS	Chip select
OE (for HM6709SH only)	Output enable
V _{SS}	Ground
V _{CC}	Power supply
NC	No connection

Pin Arrangement

HM6708SH Series**(Top View)****HM6709SH Series****(Top View)**

HM6708SH/HM6709SH Series

Block Diagram



Function Table (HM6708SH)

Input

$\overline{CS}$	$\overline{WE}$	Mode	I/O pin	V_{CC} current	Reference cycle
H	X	Not selected	High Z	I_{SB}, I_{SB1}	—
L	H	Read	Data out	I_{CC}, I_{CC1}	Read cycle (2), (3)
L	L	Write	Data in	I_{CC}, I_{CC1}	Write cycle (1), (2)

Function Table (HM6709SH)

Input

CS	$\overline{WE}$	$\overline{OE}$	Mode	I/O pin	V_{CC} current	Reference cycle
H	X	X	Not selected	High Z	I_{SB}, I_{SB1}	—
L	H	H	Output disable	High Z	I_{CC}, I_{CC1}	—
L	H	L	Read	Data out	I_{CC}, I_{CC1}	Read cycle (1), (2), (3)
L	L	H	Write	Data in	I_{CC}, I_{CC1}	Write cycle (1), (2), (3), (4)
L	L	L	Write	Data in	I_{CC}, I_{CC1}	Write cycle (5), (6)

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage with respect to V_{SS} pin	V_{CC}	-0.5 to +7.0	V
Terminal voltage with respect to V_{SS} pin	V_T	-0.5 to $V_{CC} + 0.5$	V
Power dissipation	P_T	1.0	W
Operating temperature range	T_{opr}	0 to +70	°C
Storage temperature range (with bias)	T_{stg} (Bias)	-10 to +85	°C
Storage temperature range	T_{stg}	-55 to +125	°C

For the AC and DC specifications shown in these tables, the devices were tested with a minimum transverse air flow exceeding 500 linear feet per minute.

Recommended DC Operating Conditions ($0^{\circ}\text{C} \leq T_a \leq 70^{\circ}\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V_{CC}	4.5	5.0	5.5	V
	V_{SS}	0.0	0.0	0.0	V
Input high voltage	V_{IH}	2.2	—	$V_{CC} + 0.5$	V
Input low voltage	V_{IL}	-3.0 ¹	—	0.8	V

Note: 1. Pulse width 10 ns, DC: -0.5 V

HM6708SH/HM6709SH Series

DC Characteristics ($V_{CC} = 5.0 \text{ V} \pm 10\%$, $T_a = 0 \text{ to } +70^\circ\text{C}$)

HM6708SH/HM6709SH

Parameter	Symbol	-10			-12			Unit	Test conditions
		Min	Typ*1	Max	Min	Typ*1	Max		
Input leakage current	$ I_{LI} $	—	—	2	—	—	2	μA	$V_{CC} = 5.5 \text{ V}$, $V_{IN} = 0 \text{ V}$ to V_{CC}
Output leakage current	$ I_{LO} $	—	—	10	—	—	10	μA	$\overline{CS} = V_{IH}$ or $\overline{OE} = V_{IH}$, $WE = V_{IL}$, $V_{IO} = 0 \text{ V}$ to V_{CC}
Operating power supply current	I_{CC}	—	60	100	—	60	100	mA	$\overline{CS} = V_{IL}$, $I_{IO} = 0 \text{ mA}$
Average operating current	I_{CC1}	—	130	180	—	120	175	mA	Min. cycle, $I_{IO} = 0 \text{ mA}$
Standby power supply current	I_{SB}	—	—	40	—	—	40	mA	$\overline{CS} = V_{IH}$, $V_{IN} = V_{IH}$ or V_{IL}
	I_{SB1}	—	—	30	—	—	30	mA	$\overline{CS} \geq V_{CC} - 0.2 \text{ V}$, $V_{IN} \leq 0.2 \text{ V}$ or $V_{IN} \geq V_{CC} - 0.2 \text{ V}$
Output low voltage	V_{OL}	—	—	0.4	—	—	0.4	V	$I_{OL} = 8 \text{ mA}$
Output high voltage	V_{OH}	2.4	—	—	2.4	—	—	V	$I_{OH} = -4 \text{ mA}$

Note: 1. Typical limits are: $V_{CC} = 5.0 \text{ V}$, $T_a = 25^\circ\text{C}$, and specified loading.

Capacitance ($T_a = 25^\circ\text{C}$, $f = 1 \text{ MHz}$)

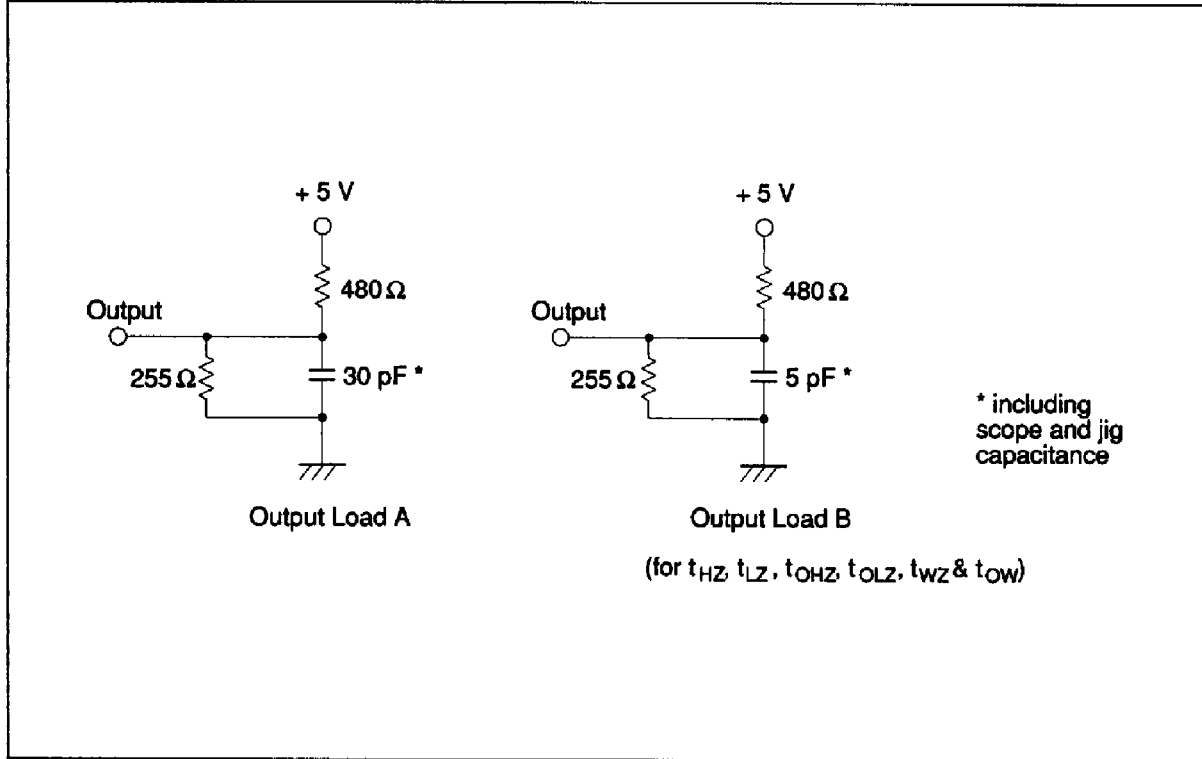
Parameter	Symbol	Max	Unit	Test condition
Input capacitance	C_{in}^{*1}	6	pF	$V_{in} = 0 \text{ V}$
Output capacitance	C_{IO}^{*1}	10	pF	$V_{IO} = 0 \text{ V}$

Note: 1. This parameter is sampled and is not 100% tested.

AC Characteristics ($V_{CC} = 5\text{ V} \pm 10\%$, $T_a = 0^\circ\text{C}$ to $+70^\circ\text{C}$ unless otherwise noted)

Test Conditions

- Input pulse levels: V_{SS} to 3.0 V
- Input timing reference levels: 1.5 V
- Output load: See figure
- Input rise and fall times: 4 ns
- Output reference levels: 1.5 V



Read Cycle

		HM6708SH/HM6709SH				
		-10		-12		
Parameter	Symbol	Min	Max	Min	Max	Unit
Read cycle time	t _{RC}	10	—	12	—	ns
Address access time	t _{AA}	—	10	—	12	ns
Chip select access time	t _{ACS}	—	10	—	12	ns
Chip selection to output in low Z	t _{LZ} *1, *2	3	—	3	—	ns
Output enable to output valid	t _{OE} *3	—	5	—	6	ns

HM6708SH/HM6709SH Series

Read Cycle (cont)

		HM6708SH/HM6709SH				
		-10		-12		
Parameter	Symbol	Min	Max	Min	Max	Unit
Output enable to output in low Z	t _{OLZ} *1, *2, *3	0	—	0	—	ns
Chip deselection to output in high Z	t _{HZ} *1, *2	0	5	0	5	ns
Output hold from address change	t _{OH}	3	—	3	—	ns

- Notes:
1. This parameter is sampled and is not 100% tested.
 2. Transition is measured ± 200 mV from steady state voltage with specified loading in Load (B).
 3. These parameters are for HM6709SH.

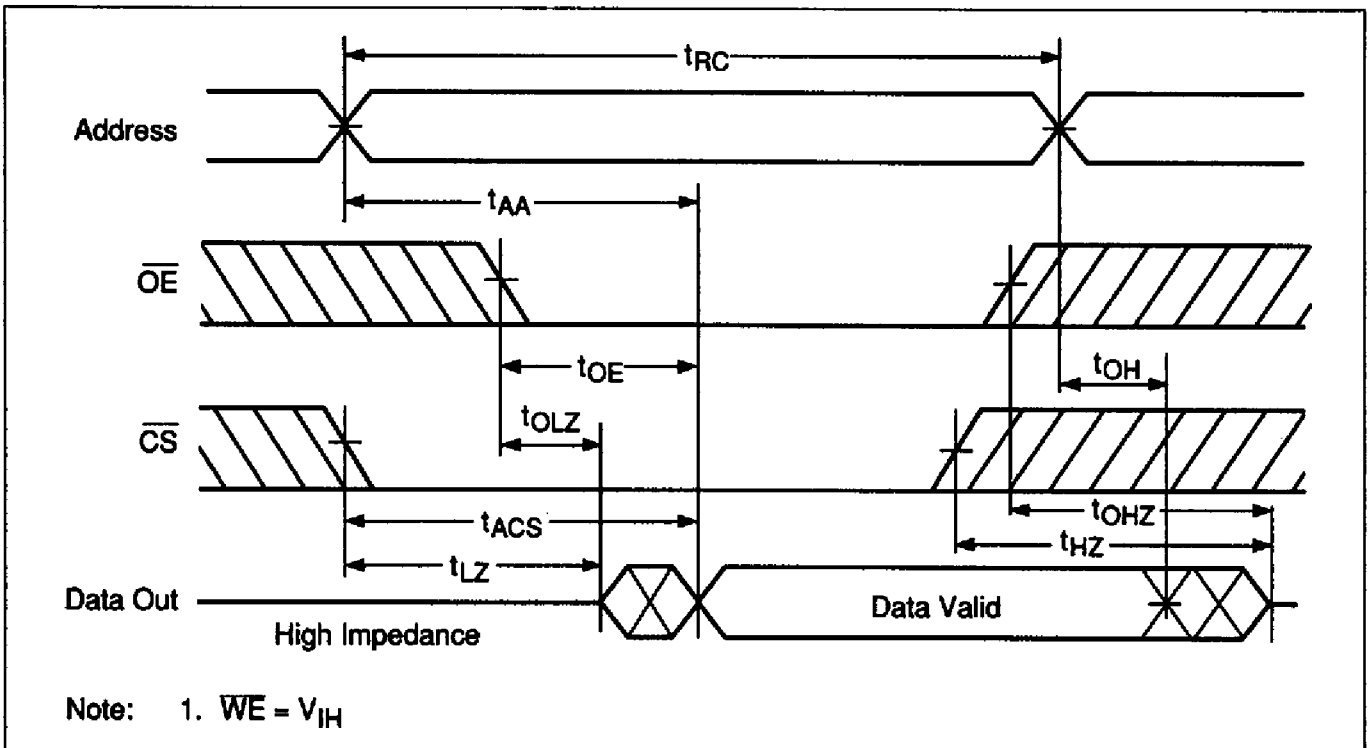
Write Cycle

		HM6708SH/HM6709SH				
		-10		-12		
Parameter	Symbol	Min	Max	Min	Max	Unit
Write cycle time	t_{WC}^{*1}	10	—	12	—	ns
Chip selection to end of write	t_{CW}	8	—	9	—	ns
Address valid to end of write	t_{AW}	10	—	11	—	ns
Address setup time	t_{AS}	0	—	0	—	ns
Write pulse width	t_{WP}	8	—	9	—	ns
Write recovery time	t_{WR}	0	—	0	—	ns
Data valid to end of write	t_{DW}	6	—	6	—	ns
Data hold time	t_{DH}	0	—	0	—	ns
Write enable to output in high Z	$t_{WZ}^{*2, *3}$	0	5	0	6	ns
Output disable to output in high Z	$t_{OHZ}^{*2, *3, *4}$	0	6	0	6	ns
Output active from end of write	$t_{OW}^{*2, *3}$	3	—	3	—	ns

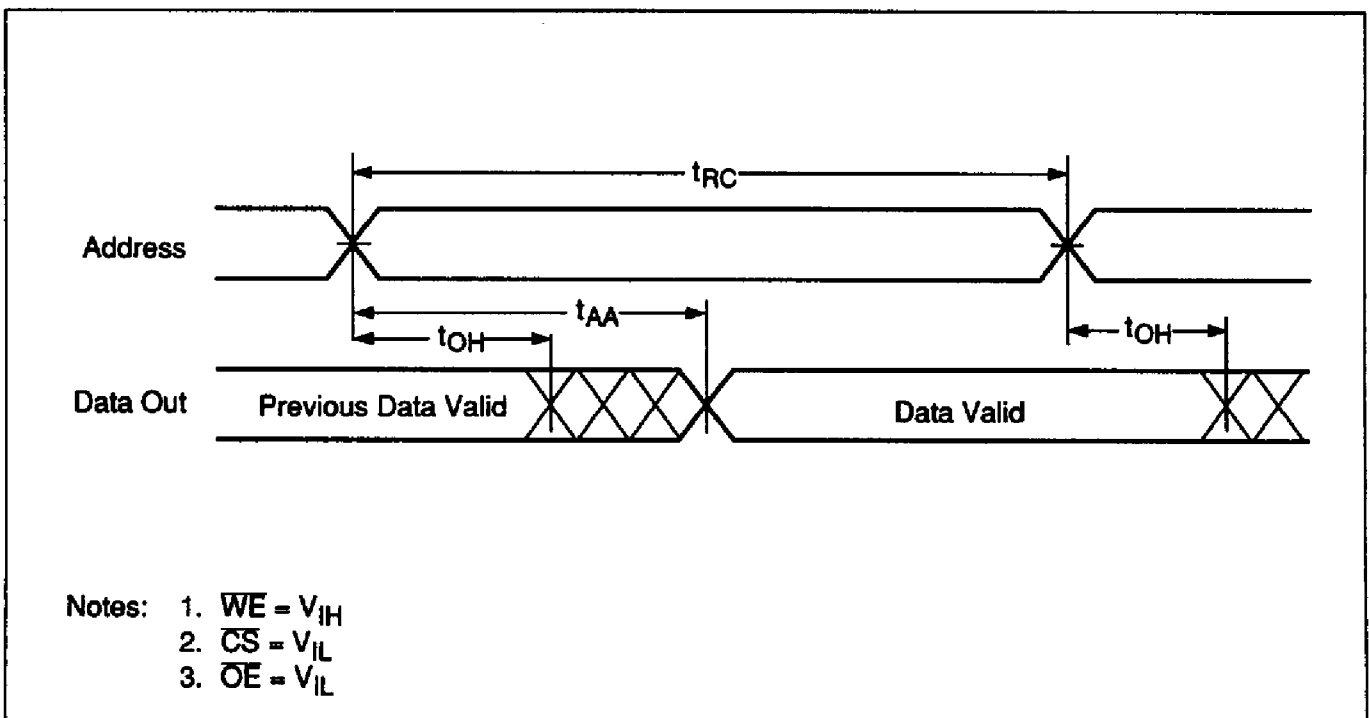
- Notes:
1. All write cycle timings are referenced from the last valid address to the first transitioning address.
 2. This parameter is sampled and is not 100% tested.
 3. Transition is measured ± 200 mV from steady state voltage with loading specified in Load (B).
 4. These parameters are for HM6709SH.

Timing Waveforms

Read Cycle 1

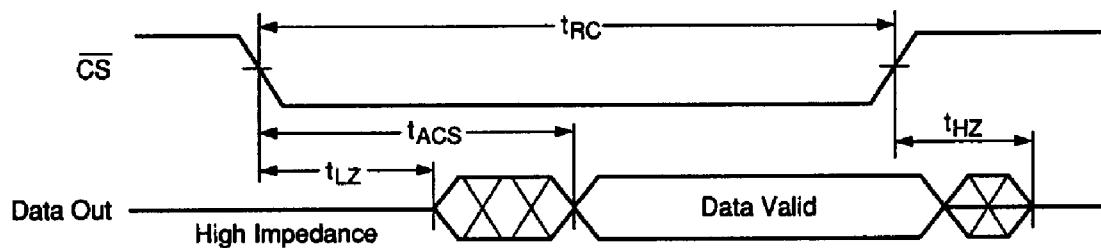


Read Cycle 2



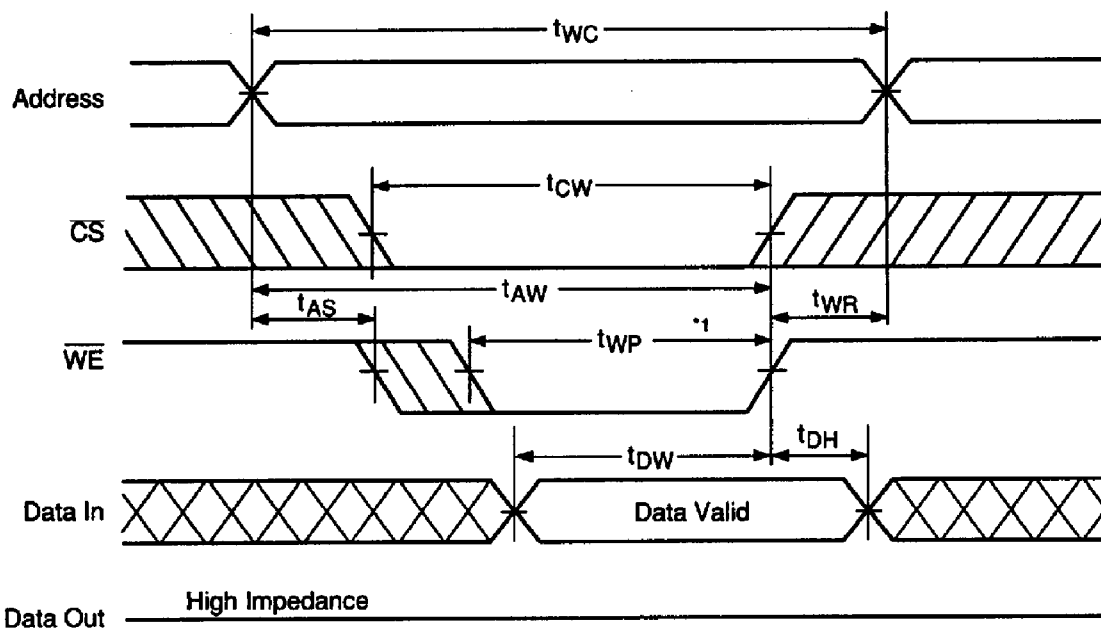
HM6708SH/HM6709SH Series

Read Cycle 3



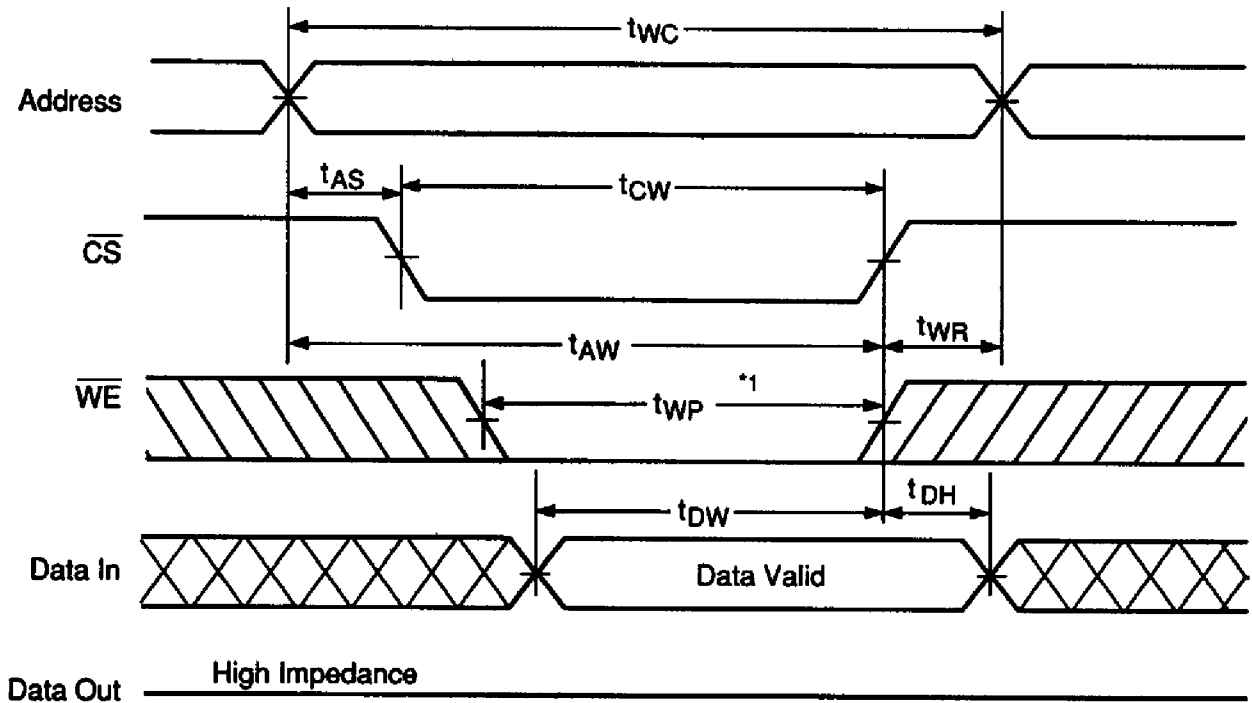
- Notes:
1. $\overline{WE} = V_{IH}$
 2. $\overline{OE} = V_{IL}$
 3. Address valid prior to or coincident with $\overline{CS}$ transition low.

Write Cycle 1 ($\overline{OE} = H$, $\overline{WE}$ controlled)



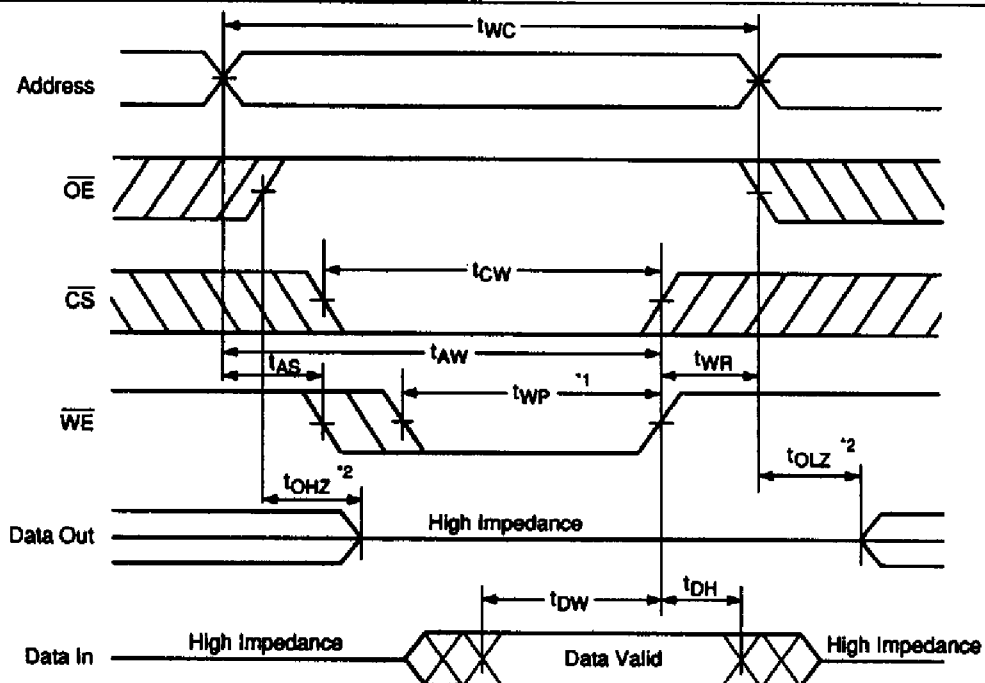
- Note:
1. A write occurs during the overlap of a low $\overline{CS}$ and a low $\overline{WE}$ (t_{WP}).

Write Cycle 2 ($\overline{OE} = H$, $\overline{CS}$ controlled)



Note: 1. A write occurs during the overlap of a low $\overline{CS}$ and a low $\overline{WE}$ (t_{WP}).

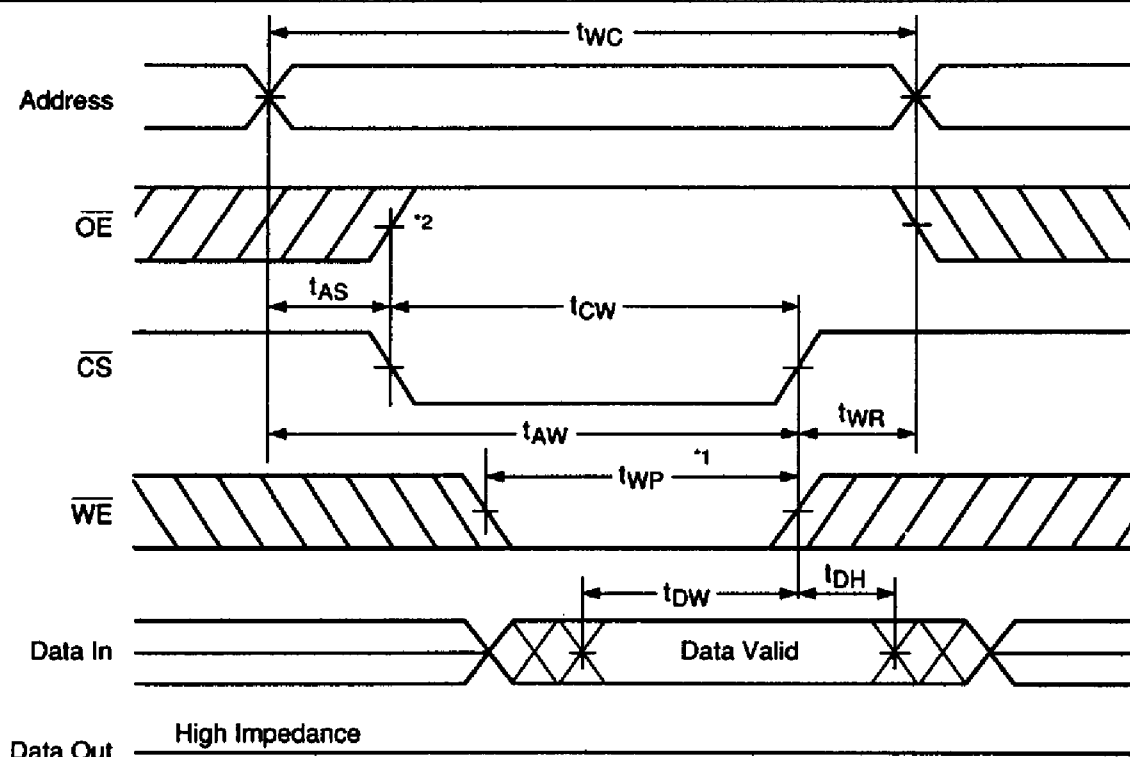
Write Cycle 3 ($\overline{OE} = \text{clocked}$, $\overline{WE}$ controlled)



- Notes: 1. A write occurs during the overlap of a low $\overline{CS}$ and a low $\overline{WE}$ (t_{WP}).
2. During this period, I/O pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.

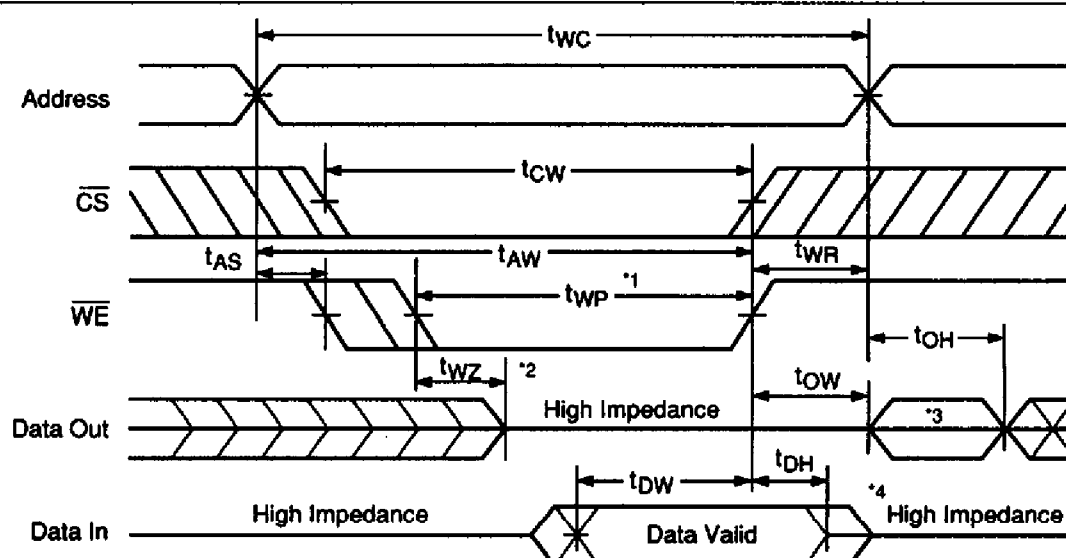
HM6708SH/HM6709SH Series

Write Cycle 4 ($\overline{OE}$ = clocked, $\overline{CS}$ controlled)



- Notes:
1. A write occurs during the overlap of a low $\overline{CS}$ and a low $\overline{WE}$ (t_{WP}).
 2. If $\overline{CS}$ low transition occurs simultaneously with the $\overline{OE}$ high transition or after the $\overline{OE}$ transition, output remain in a high impedance state.

Write Cycle 5 ($\overline{OE}$ = L, $\overline{WE}$ controlled)



- Notes:
1. A write occurs during the overlap of a low $\overline{CS}$ and a low $\overline{WE}$ (t_{WP}).
 2. During this period, I/O pins are output state so that the input signals of opposite phase to the outputs must not be applied.
 3. Output data is the same phase of write data of this write cycle.
 4. If $\overline{CS}$ is low during this period, I/O pins are in the output state. Then, the data input signals of opposite phase to the outputs must not be applied to them.

Write Cycle 6 ($\overline{OE} = L$, $\overline{CS}$ controlled)

